

ATTY DKT. NO.: AMAT/5191C1/ISM/CORE/MCVD/PJS
U.S. SERIAL NO.: UNKNOWN CONF. NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS, INC.
TITLE: APPARATUS AND METHOD FOR VAPORIZING SOLID PRECURSOR FOR
CVD OR ATOMIC LAYER
INVENTOR: LAWRENCE CHUNG-LAI LEI
EXPRESS MAIL No.: EV416701885OUS

PAGE 1 OF 3

1/3

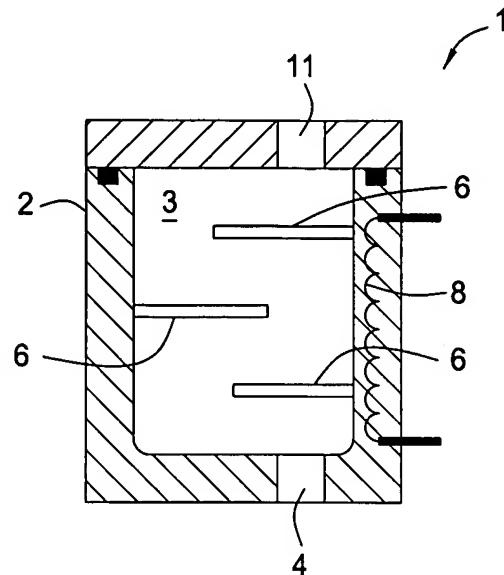


FIG. 1

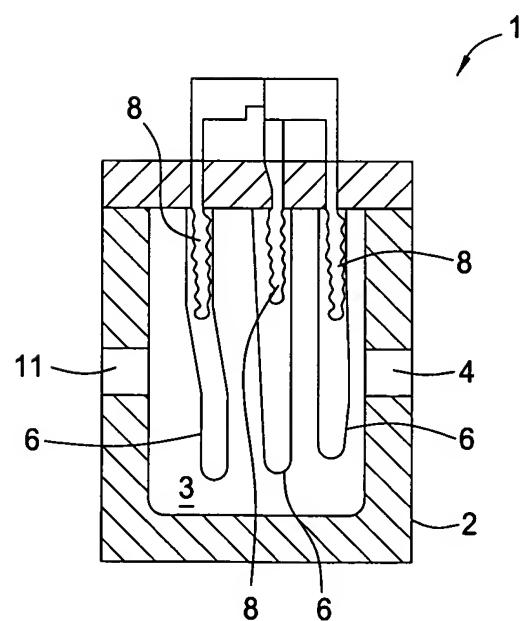


FIG. 2

ATTY DKT. No.: AMAT/5191C1/ISM/CORE/MCVD/PJS
U.S. SERIAL No.: UNKNOWN CONF. NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS, INC.
TITLE: APPARATUS AND METHOD FOR VAPORIZING SOLID PRECURSOR FOR
CVD OR ATOMIC LAYER
INVENTOR: LAWRENCE CHUNG-LAI LEI
EXPRESS MAIL No.: EV416701885OUS

PAGE 2 OF 3

2/3

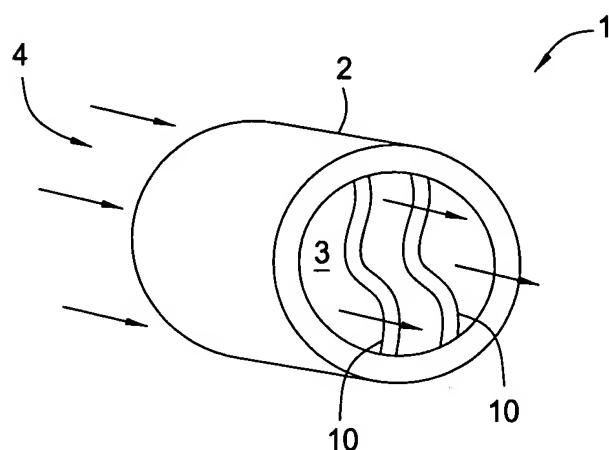


FIG. 3

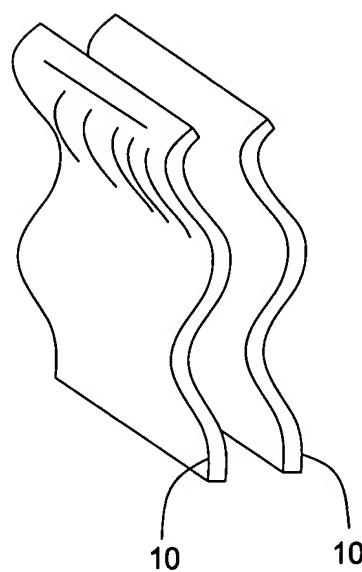


FIG. 4

ATTY DKT. NO.: AMAT/5191C1/ISM/CORE/MCVD/PJS
U.S. SERIAL NO.: UNKNOWN CONF. NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS, INC.
TITLE: APPARATUS AND METHOD FOR VAPORIZING SOLID PRECURSOR FOR
CVD OR ATOMIC LAYER
INVENTOR: LAWRENCE CHUNG-LAI LEII
EXPRESS MAIL No.: EV416701885OUS

PAGE 3 OF 3

3/3

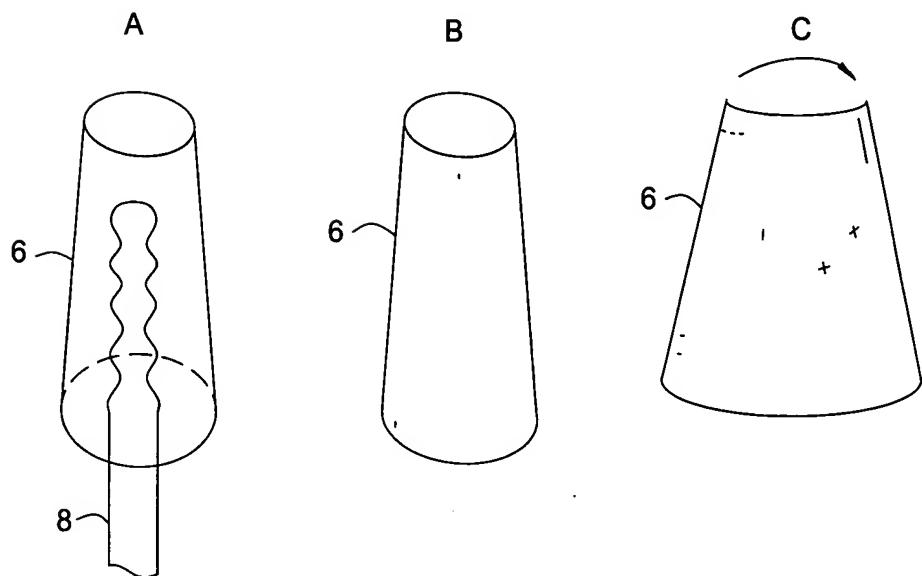


FIG. 5